

Declaration and Power of Attorney for Patent Application
特許出願宣言書
Japanese Language Declaration

私は、下欄に氏名を記載した発明者として、以下のとおり宣言する。：

私の住所、郵便の宛先および国籍は、下欄に氏名に統いて記載したとおりであり。

名前の発明に關し、請求の範囲に記載した特許を求める主題の本來の、最初にして唯一発明者である（一人の氏名のみが下欄に記載されている場合）か、もしくは本來の最初にして共同の発明者である（複数の氏名が下欄に記載されている場合）と信じ、

その明細書を
(該当する方に印を付す)
 ここに添付する。

_____ 日に出願番号
第_____号として提出し、
_____日に補正した。
(該当する場合)

私は、前記のとおり補正した請求の範囲を含む前記明細書の内容を検討し、理解したことを陳述する。

私は、連邦規則法典第37部第1章第56条(a)項に従い、本願の審査に所要の情報を開示すべき義務を有することを認める。

As a below named inventor, I hereby declare that

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled.

SEMICONDUCTOR WAFER, SEMICONDUCTOR CHIP

AND DICING METHOD OF A SEMICONDUCTOR WAFER

the specification of which
(check one)
 is attached hereto.

was filed on _____ as
Application Serial No. _____
and was amended on _____
(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with the Title 37, Code of Federal Regulations, § 1.56(a).

Japanese Language Declaration

私は、合衆国法典第 35 部第 119 条にもとづく下記の外国特許出願または発明者証出願の外国優先権利益を主張し、さらに優先権の主張に係わる基準出願の出願日前の出願日を有する外国特許出願または発明者証出願を以下に明記する：

Prior Foreign Application(s)

元の外国情報

		Priority Claimed 優先権の主張
P 2002-302993	Japan	<input checked="" type="checkbox"/> Yes あり <input type="checkbox"/> No なし (Day/Month/Year Filed) (出願の年月日)
(Number) (番号)	(Country) (国名)	<input type="checkbox"/> Yes あり <input type="checkbox"/> No なし (Day/Month/Year Filed) (出願の年月日)
(Number) (番号)	(Country) (国名)	<input type="checkbox"/> Yes あり <input type="checkbox"/> No なし (Day/Month/Year Filed) (出願の年月日)

私は、合衆国法典第 35 部第 120 条にもとづく下記の合衆国特許出願の利益を主張し、本願の請求の範囲各項に記載の主題が合衆国法典第 35 部第 112 条第 1 項に規定の態様で先の合衆国出願に開示されていない程度において、先の出願の出願日と本願の国内出願日または PCT 國際出願日の間に公表された連邦規則法典第 37 部第 1 章第 56 条(a)項に記載の所要の情報を開示すべき義務を有することを認める：

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

		Priority Claimed 優先権の主張
		<input checked="" type="checkbox"/> Yes あり <input type="checkbox"/> No なし
		<input type="checkbox"/> Yes あり <input type="checkbox"/> No なし
		<input type="checkbox"/> Yes あり <input type="checkbox"/> No なし

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56 (a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.) (出願番号)	(Filing Date) (出願日)	(Status: patented, pending, abandoned) (現況:特許済、係在中、放棄済)
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(Application Serial No.) (出願番号)	(Filing Date) (出願日)	(Status: patented, pending, abandoned) (現況:特許済、係在中、放棄済)
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私は、ここに自己の知識にもとづいて行った陳述がすべて真実であり、自己の有する情報および信ずるところに従って行った陳述が真実であると信じ、さらに故意に虚偽の陳述等を行った場合、合衆国法典第 18 部第 1001 条により、罰金もしくは禁錮に処せられるか、またはこれらの刑が併科され、またかかる故意による虚偽の陳述が本願ないし本願に対して付与される特許の有効性を損うことがあることを認識して、以上の陳述を行ったことを宣言する。

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Japanese Language Declaration

委任状：私は、下記発明者として、以下の代理人をここに委任し、本願の手続を遂行すること並びにこれに関する一切の行為を特許商標庁に対して行うことを委任する。（代理人氏名および登録番号を明記のこと）

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書類の送付先：

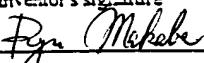
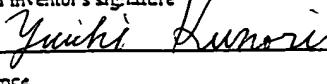
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（第三またはそれ以後の共同発明者に対して同様な情報および署名を提供すること。）

(Supply similar information and signature for third and subsequent joint inventors.)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 20277
Ryu MAKABE, et al. : Confirmation Number:
Serial No.: : Group Art Unit:
Filed: September 16, 2003 : Examiner: Unknown
For: SEMICONDUCTOR WAFER, SEMICONDUCTOR CHIP AND DICING
METHOD OF A SEMICONDUCTOR WAFER

ASSOCIATE POWER OF ATTORNEY

Mail Stop
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The undersigned Principal Attorney of record hereby appoints the following Attorneys as his Associates with regard to the above-identified application: Steven W. Allis, Reg. No. 50,532; Stephen A. Becker, Reg. No. 26,527; John G. Bisbikis, Reg. No. 37,095; Daniel Bucca, Reg. No. 42,368; Kenneth L. Cage, Reg. No. 26,151; Jennifer Chen, Reg. No. 42,404; Bernard P. Codd, Reg. No. 46,429; Lawrence T. Cullen, Reg. No. 44,489; Paul Devinsky, Reg. No. 28,553; Margaret M. Duncan, Reg. No. 30,879; Shamita De. Etienne-Cummings, Reg. No. 46,072; Ramyar M. Farid, Reg. No. 46,692; Brian E. Ferguson, Reg. No. 36,801; Michael E. Fogarty, Reg. No. 36,139; John R. Fuisz, Reg. No. 37,327; Keith E. George, Reg. No. 34,111; John A. Hankins, Reg. No. 32,029; Eric J. Kraus, Reg. No. 36,190; Catherine Krupka, Reg. No. 46,227; Jack Q. Lever, Reg. No. 28,149; Raphael V. Lupo, Reg. No. 28,363; Burman Y. Mathis III, Reg. No. 44,907; Michael A. Messina, Reg. No. 33,424; Dawn L. Palmer, Reg. No. 41,238; Joseph H. Paquin, Jr., Reg. No. 31,647; Scott D. Paul, Reg. No. 42,984; William D. Pegg, Reg. No. 42,988; Robert L. Price, Reg. No. 22,685; Gene Z. Rubinson, Reg. No. 33,351; Brian K. Seidleck, Reg. No. 51,321; Joy Ann G. Serauskas, Reg. No. 27,952; Jiri F. Smetana, Reg. No. 52,456; David A. Spenard, Reg. No. 37,449; Arthur J. Steiner, Reg. No. 26,106; Michael D. Switzer, Reg. No. 39,552; David M. Tennant, Reg. No. 48,362; Judith L. Toffenetti, Reg. No. 39,048; Daniel S. Trainor, Reg. No. 43,959; Shival P. Virmani, Reg. No. 45,032; Kelli N. Watson, Reg. No. 47,170;

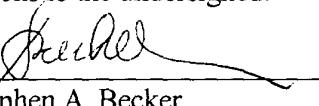
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September 16, 2003

By 
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